

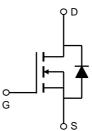
# **General Description**

The AO4484 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  with low gate charge. This is an all purpose device that is suitable for use in a wide range of power conversion applications.

## Features

$(V_{GS} = 10V)$
$(V_{GS} = 10V)$
$(V_{GS} = 4.5V)$





Parameter		Symbol	10 Sec	Steady State	Units	
Drain-Source Voltage		V <sub>DS</sub>	40		V	
Gate-Source Voltage		V <sub>GS</sub>	±20		V	
Continuous Drain	T <sub>A</sub> =25℃		13.5	10		
Current <sup>A</sup>	T <sub>A</sub> =70℃	I <sub>D</sub>	10.8	8	۸	
Pulsed Drain Current <sup>B</sup>		I <sub>DM</sub>	120		A	
Avalanche Current G		I <sub>AR</sub>	23			
Repetitive avalanche energy L=0.3mH G		E <sub>AR</sub>	79		mJ	
Power Dissipation <sup>A</sup>	T <sub>A</sub> =25℃	-P <sub>D</sub>	3.1	1.7	W	
	T <sub>A</sub> =70℃	r D	2.0	1.1	VV	
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55	to 150	C	

Thermal Characteristics						
Parameter		Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient <sup>A</sup>	t ≤ 10s	Р	31	40	C/W	
Maximum Junction-to-Ambient A	Steady State	$R_{ extsf{ heta}JA}$	59	75	°C/W	
Maximum Junction-to-Lead <sup>C</sup>	Steady State	$R_{ ext{ hetaJL}}$	16	24	°C/W	



#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC P	PARAMETERS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$		40			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 40V, V_{GS} = 0V$				1	
			T <sub>J</sub> = 55℃			5	μA
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$				±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250 \mu A$		1.7	2.2	3	V
I <sub>D(ON)</sub>	On state drain current	$V_{GS} = 10V, V_{DS} = 5V$		120			А
		$V_{GS} = 10V, I_{D} = 10A$			8.2	10	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance		T_=125℃		12.5	16	mΩ
		$V_{GS} = 4.5V, I_{D} = 8A$			10	12.5	
<b>g</b> fs	Forward Transconductance	$V_{DS} = 5V, I_{D} = 10A$			75		S
V <sub>SD</sub>	Diode Forward Voltage	$I_{\rm S} = 1$ A, $V_{\rm GS} = 0$ V			0.72	1	V
I <sub>S</sub>	Maximum Body-Diode Continuous Curr	rent				2.5	А
DYNAMIC	PARAMETERS						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =20V, f=1MHz			1500	1950	pF
C <sub>oss</sub>	Output Capacitance				215		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				135		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		2	3.5	5	Ω
SWITCHI	NG PARAMETERS						
Q <sub>g</sub> (10V)	Total Gate Charge	– V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, I <sub>D</sub> =10A			27.2	37	nC
Q <sub>g</sub> (4.5V)	Total Gate Charge				13.6	18	nC
Q <sub>gs</sub>	Gate Source Charge				4.5		nC
Q <sub>gd</sub>	Gate Drain Charge				6.4		nC
t <sub>D(on)</sub>	Turn-On DelayTime				6.4		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =10V, $V_{DS}$ =20V, $R_{L}$ = 2 $\Omega$ , $R_{GEN}$ =3 $\Omega$			17.2		ns
t <sub>D(off)</sub>	Turn-Off DelayTime				29.6		ns
t <sub>f</sub>	Turn-Off Fall Time				16.8		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =10A, dl/dt=100A/µ	S		30	40	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	, I <sub>F</sub> =10A, dI/dt=100A/μs			19		nC

A: The value of R<sub>0JA</sub> is measured with the device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> = 25°C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R  $_{\rm 6JA}$  is the sum of the thermal impedence from junction to lead R  $_{\rm 6JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using t  $\leqslant$  300  $\mu s$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^{\circ}$ C. The SOA curve provides a single pulse rating.

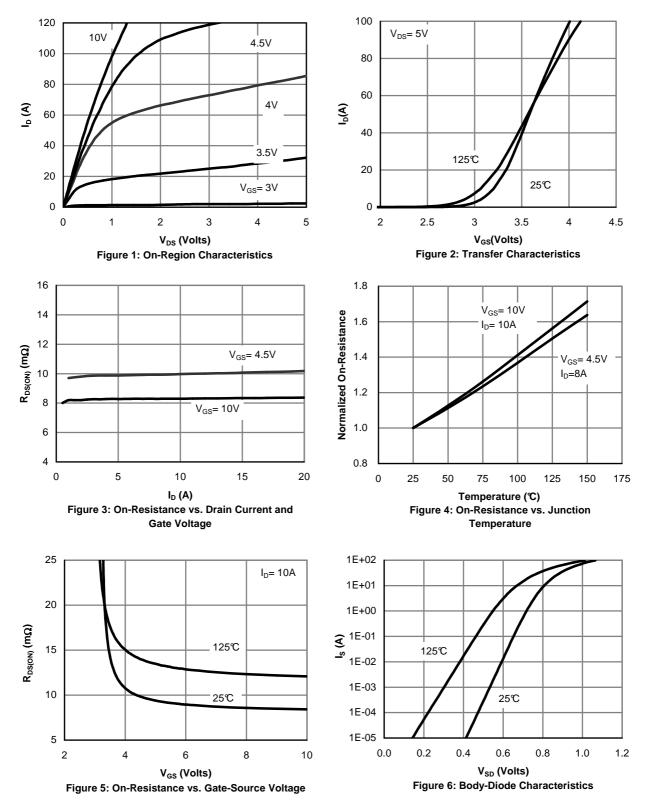
F. The current rating is based on the t  $\leq$  10s thermal resistance rating.

G.  $E_{AR}$  and  $I_{AR}$  ratings are based on low frequency and duty cycles to keep  $T_j$ =25C.

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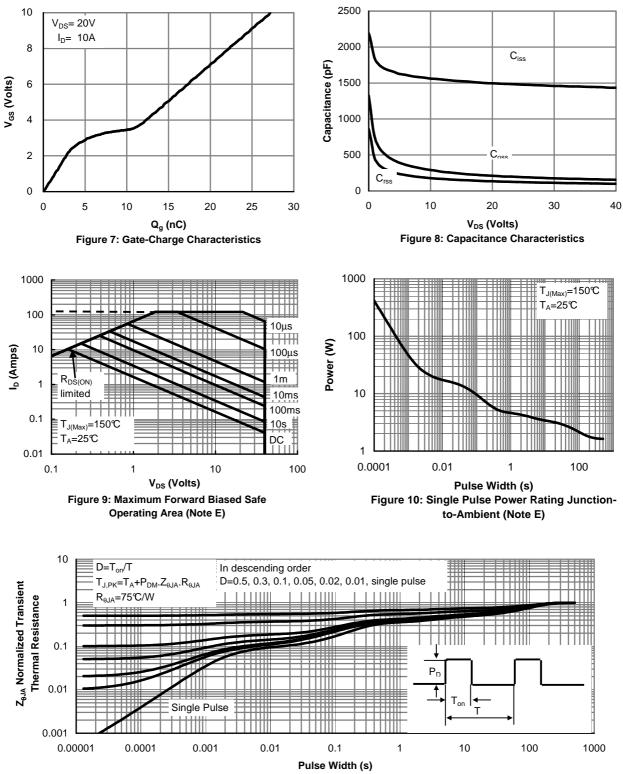


### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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